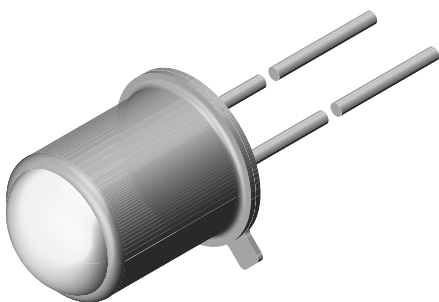




Infrared Emitting Diode, 950 nm, GaAlAs, MQW



FEATURES

- Package type: leaded
- Package form: TO-18
- Dimensions (in mm): \varnothing 4.7
- Peak wavelength: $\lambda_p = 950$ nm
- High reliability
- High radiant power
- High radiant intensity
- Angle of half intensity: $\varphi = \pm 4^\circ$
- Low forward voltage
- Good spectral matching with Si photodetectors
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT

DESCRIPTION

TSTS7100 is an infrared, 950 nm emitting diode in GaAlAs multi quantum well (MQW) technology in a hermetically sealed TO-18 package with lens.

APPLICATIONS

- Radiation source in near infrared range

PRODUCT SUMMARY

| COMPONENT | I_e (mW/sr) | φ (°) | λ_p (nm) | t_r (ns) |
|-----------|---------------|---------------|------------------|------------|
| TSTS7100 | 105 | ± 4 | 950 | 15 |

Note

- Test conditions see table "Basic Characteristics"

ORDERING INFORMATION

| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM |
|---------------|-----------|------------------------------|--------------|
| TSTS7100 | Bulk | MOQ: 1000 pcs, 1000 pcs/bulk | TO-18 |

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
|--|------------------------------|------------|-------------|------------------|
| Reverse voltage | | V_R | 5 | V |
| Forward current | | I_F | 100 | mA |
| Power dissipation | | P_V | 170 | mW |
| Junction temperature | | T_j | 125 | $^\circ\text{C}$ |
| Ambient temperature range | | T_{amb} | -40 to +85 | $^\circ\text{C}$ |
| Storage temperature range | | T_{stg} | -40 to +110 | $^\circ\text{C}$ |
| Soldering temperature | $t \leq 5$ s, 2 mm from case | T_{sd} | 260 | $^\circ\text{C}$ |
| Thermal resistance junction to ambient | J-STD-051 | R_{thJA} | 500 | K/W |

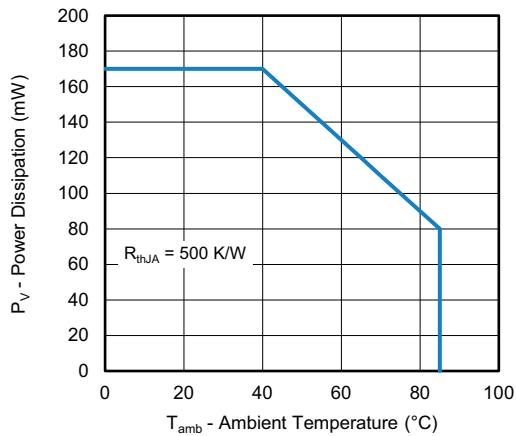


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

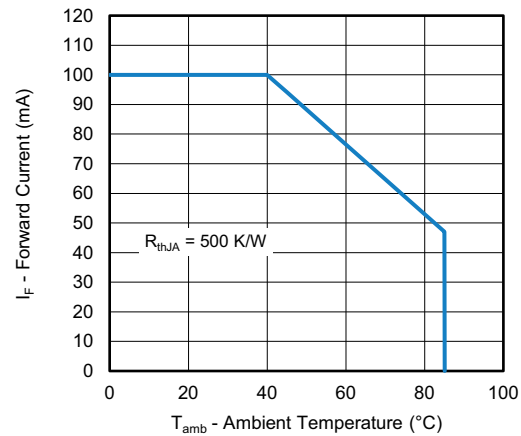


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS ($T_{amb} = 25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|--|--|------------------|------------------------------------|---------|------|---------------|
| Forward voltage | $I_F = 100\text{ mA}$, $t_p = 20\text{ ms}$ | V_F | - | 1.4 | 1.7 | V |
| | $I_F = 1\text{ A}$, $t_p = 100\text{ }\mu\text{s}$ | V_F | - | 2.2 | - | V |
| Temperature coefficient of V_F | $I_F = 100\text{ mA}$, $t_p = 20\text{ ms}$ | TK_{V_F} | - | -1.1 | - | mV/K |
| Reverse current | | I_R | Not designed for reverse operation | | | μA |
| Junction capacitance | $V_R = 0\text{ V}$, $f = 1\text{ MHz}$, $E = 0\text{ mW/cm}^2$ | C_j | - | 56 | - | pF |
| Radiant intensity | $I_F = 100\text{ mA}$, $t_p = 20\text{ ms}$ | I_e | 65 | 105 | 185 | mW/sr |
| Radiant power | $I_F = 100\text{ mA}$, $t_p = 20\text{ ms}$ | ϕ_e | - | 17 | - | mW |
| Temperature coefficient of ϕ_e | $I_F = 100\text{ mA}$, $t_p = 20\text{ ms}$ | TK_{ϕ_e} | - | -0.5 | - | %/K |
| Angle of half intensity | | ϕ | - | ± 4 | - | ° |
| Peak wavelength | $I_F = 100\text{ mA}$, $t_p = 20\text{ ms}$ | λ_p | - | 950 | - | nm |
| Spectral bandwidth | | $\Delta\lambda$ | - | 30 | - | nm |
| Temperature coefficient of λ_p | $I_F = 100\text{ mA}$, $t_p = 20\text{ ms}$ | TK_{λ_p} | - | 0.2 | - | %/K |
| Rise time | $I_F = 100\text{ mA}$ | t_r | - | 15 | - | ns |
| Fall time | $I_F = 100\text{ mA}$ | t_f | - | 15 | - | ns |

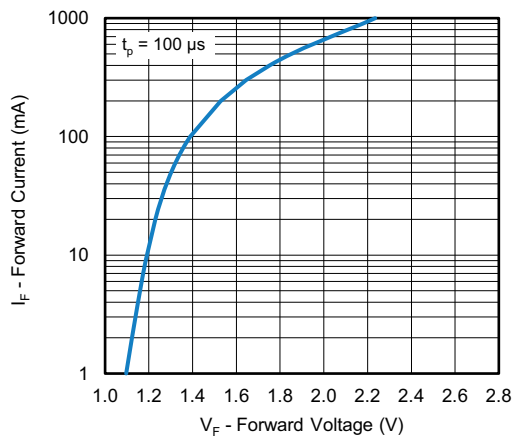
**BASIC CHARACTERISTICS** ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

Fig. 3 - Forward Current vs. Forward Voltage

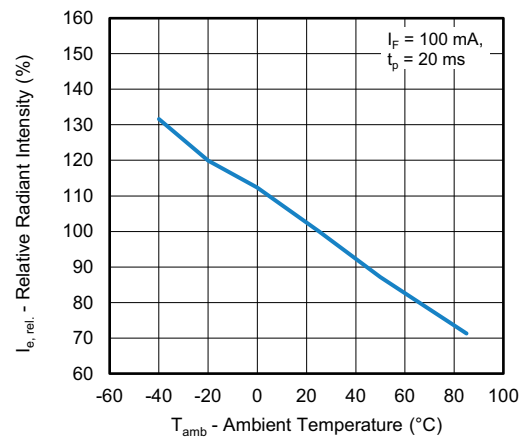


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

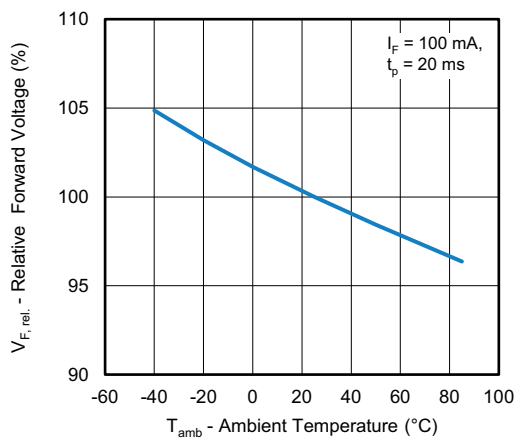


Fig. 4 - Forward Voltage vs. Ambient Temperature

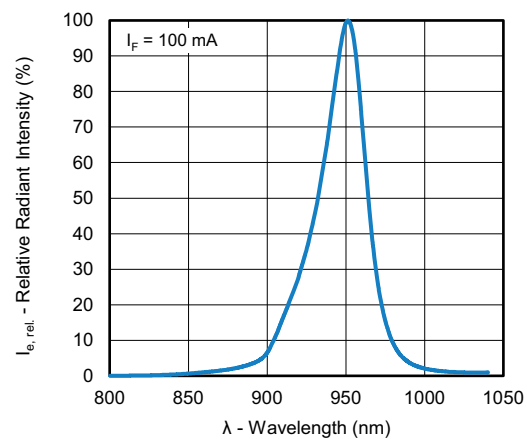


Fig. 7 - Relative Radiant Intensity vs. Wavelength

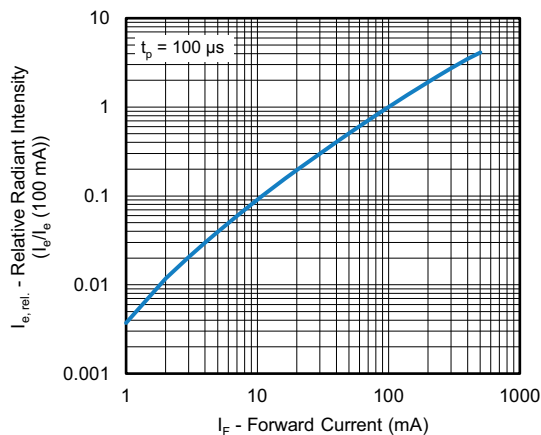


Fig. 5 - Relative Radiant Intensity vs. Forward Current

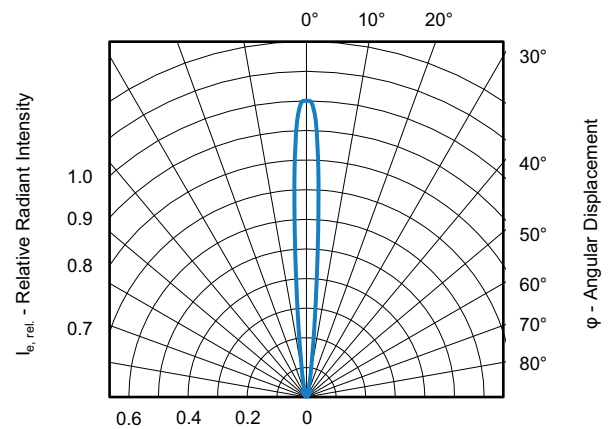
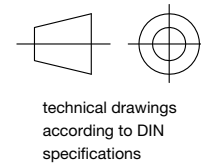
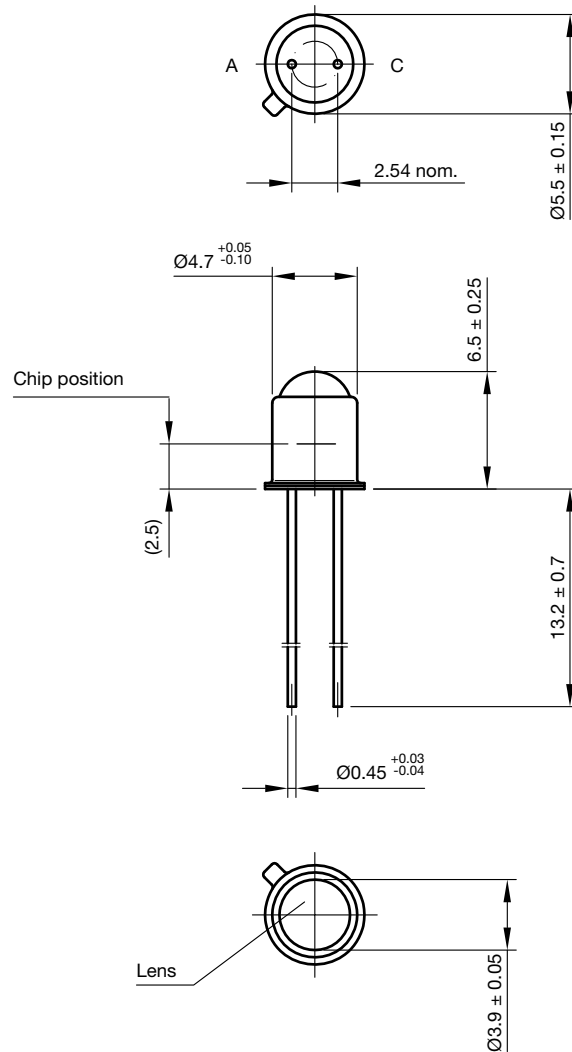


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement



PACKAGE DIMENSIONS in millimeters



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